08-23-	2004		****
FORM PTO-1595		HEET	U.S. DEPARTMENT OF COMMERCE
1/31/92			Patent and Trademark Office
To the Honorable Commiss 10182 thereof.	1308	i the attache	ed original documents or copy
1, Name of conveying party(ies):  KAZUSHI SATO YU LIU NAOFUMI YANAGIHARA  Additional name(s) of conveying party(ies) attached?  Yes  No  3. Nature of conveyance:  Assignment  Security Agreement  Change of Name Other	Internal Add	Sony Corpo	
<ol> <li>Application (number(s) or patent number(s) If this document is being filed together with a</li> <li>A. Patent Application No.(s)         <ul> <li>U.S. Serial No. 09/708,255 filed Novem</li> <li>Old Attorney Docket No. SONY-U0406</li> <li>Attorney Docket No. 097092909-4912</li> </ul> </li> </ol>	new application, B: aber 7, 2000	the execution Patent No.(s)	_
Additional numbers attached?   Yes   No			
5. Name and address of party to whom correspondence concerning document should mailed:  SONNENSCHEIN NATH & ROSENTHA	i be 7. Total Fe ⊠ Encl	ee (37 CFR 3.4	ications and patents involved  1 1\$ 40.00  harged to deposit account any
P.O. Box #061080	l l	tional fees	
Wacker Drive Station	8. Deposit	: Account Nun 19.3140	nber:
Sears Tower Chicago, IL 60606-1080 Customer ID No. 26263	(Attach du	plicate copy of thi	s page if paying by deposit account)
DO NOT USE THIS SPACE		<u></u>	
9. Statement and signature: To the best of my knowledge and belief, the focopy is a true copy of the original document.  David R. Metzger  Name of Person Signing	Signature	tion is true an	d correct and any attached  August 9, 2001  Date  Total number of pages 3
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GTDN11 00000117 09708255 40.00 DP			

08/22/2001 01 FC:581

## ASSIGNMENT

Docket Number: SONY-U0406

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in APPARATUS AND METHOD FOR TRANSFORMING PICTURE INFORMATION

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/708, 255 Filing Date: 11/7/2000.

This assignment executed on the dates indicated below.

KAZUSHI SATO	
Name of first or sole inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of first/or søle inventor  Residence of first/or søle inventor  Residence of first/or søle inventor  Residence of first/or søle inventor	July 06, 200/
Signature of terst or sole inventor	Date of this assignment

PATENT REEL: 012086 FRAME: 0807

Yu Liu	
Name of second inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of second inventor	July 26, 200/ Date of this assignment
Signature of second inventor	Date of this assignment
NAOFUMI YANAGIHARA	
Name of third inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of third inventor  Signature of third inventor	July 6, 200 / Date of this assignment
Name of fourth inventor	Execution date of U.S. Patent Application
Residence of fourth inventor	
Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

PATENT
RECORDED: 08/13/2001 REEL: 012086 FRAME: 0808